

# **NSVDTC114YM3T5G Datasheet**

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DiGi Electronics Part Number	NSVDTC114YM3T5G-DG
Manufacturer	onsemi
Ianufacturer Product Number	NSVDTC114YM3T5G
Description	TRANS PREBIAS NPN 50V SOT723
Detailed Description	Pre-Biased Bipolar Transistor (BJT) NPN - Pre-Biase d 50 V 100 mA 260 mW Surface Mount SOT-723

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# Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
NSVDTC114YM3T5G	onsemi
Series:	Product Status:
	Active
Transistor Type:	Current - Collector (Ic) (Max):
NPN - Pre-Biased	100 mA
Voltage - Collector Emitter Breakdown (Max):	Resistor - Base (R1):
50 V	10 kOhms
Resistor - Emitter Base (R2):	DC Current Gain (hFE) (Min) @ lc, Vce:
47 kOhms	80 @ 5mA, 10V
Vce Saturation (Max) @ lb, lc:	Current - Collector Cutoff (Max):
250mV @ 300μA, 10mA	500nA
Power - Max:	Grade:
260 mW	Automotive
Qualification:	Mounting Type:
AEC-Q101	Surface Mount
Package / Case:	Supplier Device Package:
SOT-723	SOT-723
Base Product Number:	
NSVDTC114	

# **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.21.0095	

# **Digital Transistors (BRT)** R1 = 10 k $\Omega$ , R2 = 47 k $\Omega$

# NPN Transistors with Monolithic Bias Resistor Network

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

#### Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$ )

Rating	Symbol	Max	Unit
Collector-Base Voltage	V <sub>CBO</sub>	50	Vdc
Collector-Emitter Voltage	V <sub>CEO</sub>	50	Vdc
Collector Current – Continuous	۱ <sub>C</sub>	100	mAdc
Input Forward Voltage	V <sub>IN(fwd)</sub>	40	Vdc
Input Reverse Voltage	V <sub>IN(rev)</sub>	6	Vdc

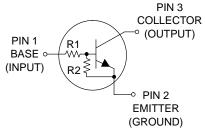
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

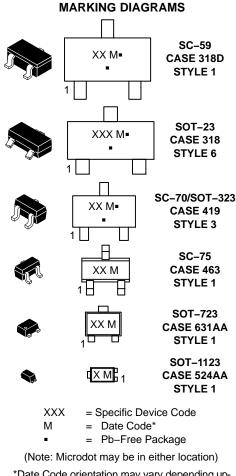


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\*Date Code orientation may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

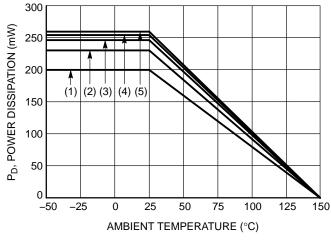
See detailed ordering, marking, and shipping information in the package dimensions section on page 2 of this data sheet.

#### Table 1. ORDERING INFORMATION

Device	Part Marking	Package	Shipping <sup>†</sup>
MUN2214T1G, SMUN2214T1G*	8D	SC–59 (Pb–Free)	3000 / Tape & Reel
MUN2214T3G, SMUN2214T3G*	8D	SC–59 (Pb–Free)	10000 / Tape & Reel
MMUN2214LT1G, SMMUN2214LT1G*	A8D	SOT-23 (Pb-Free)	3000 / Tape & Reel
MUN5214T1G, SMUN5214T1G*	8D	SC-70/SOT-323 (Pb-Free)	3000 / Tape & Reel
DTC114YET1G, SDTC114YET1G	8D	SC-75 (Pb-Free)	3000 / Tape & Reel
DTC114YM3T5G, NSVDTC114YM3T5G*	8D	SOT-723 (Pb-Free)	8000 / Tape & Reel
NSBC114YF3T5G	J	SOT-1123 (Pb-Free)	8000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.



(1) SC-75 and SC-70/SOT-323; Minimum Pad
(2) SC-59; Minimum Pad
(3) SOT-23; Minimum Pad
(4) SOT-1123; 100 mm<sup>2</sup>, 1 oz. copper trace
(5) SOT-723; Minimum Pad

Figure 1. Derating Curve

#### **Table 2. THERMAL CHARACTERISTICS**

Characteristic		Symbol	Max	Unit
THERMAL CHARACTERISTICS (SC-59) (MUN2214)				
Total Device Dissipation $T_A = 25^{\circ}C$	(Note 1) (Note 2) (Note 1)	P <sub>D</sub>	230 338	mW mW/°C
Derate above 25°C	(Note 1) (Note 2)		1.8 2.7	mw/ C
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	$R_{\thetaJA}$	540 370	°C/W
Thermal Resistance, Junction to Lead	(Note 1) (Note 2)	$R_{\theta JL}$	264 287	°C/W
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
THERMAL CHARACTERISTICS (SOT-23) (MMUN2214L)				
Total Device Dissipation $T_A = 25^{\circ}C$	(Note 1) (Note 2)	PD	246 400	mW
Derate above 25°C	(Note 1) (Note 2)		2.0 3.2	mW/°C
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	$R_{\thetaJA}$	508 311	°C/W
Thermal Resistance, Junction to Lead	(Note 1) (Note 2)	$R_{\thetaJL}$	174 208	°C/W
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
THERMAL CHARACTERISTICS (SC-70/SOT-323) (MUN5214)				
Total Device Dissipation $T_A = 25^{\circ}C$	(Note 1) (Note 2)	PD	202 310	mW
Derate above 25°C	(Note 1) (Note 2)		1.6 2.5	mW/°C
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	$R_{\theta J A}$	618 403	°C/W
Thermal Resistance, Junction to Lead	(Note 1) (Note 2)	$R_{\thetaJL}$	280 332	°C/W
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
THERMAL CHARACTERISTICS (SC-75) (DTC114YE)				
Total Device Dissipation $T_A = 25^{\circ}C$	(Note 1)	PD	200	mW
	(Note 2)		300	
Derate above 25°C	(Note 1) (Note 2)		1.6 2.4	mW/⁰C
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	$R_{\thetaJA}$	600 400	°C/W
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
THERMAL CHARACTERISTICS (SOT-723) (DTC114YM3)				
Total Device Dissipation $T_{1} = 25^{\circ}C$	(Note 1)	PD	260	mW
$T_A = 25^{\circ}C$	(Note 2)		600	
Derate above 25°C	(Note 1) (Note 2)		2.0 4.8	mW/°C
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	$R_{\thetaJA}$	480 205	°C/W
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

FR-4 @ Minimum Pad.
 FR-4 @ 1.0 x 1.0 Inch Pad.
 FR-4 @ 100 mm<sup>2</sup>, 1 oz. copper traces, still air.
 FR-4 @ 500 mm<sup>2</sup>, 1 oz. copper traces, still air.

#### **Table 2. THERMAL CHARACTERISTICS**

Characteristic	Symbol	Мах	Unit	
THERMAL CHARACTERISTICS (SOT-1123) (NSBC114YF3)				
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C	(Note 3) (Note 4) (Note 3) (Note 4)	P <sub>D</sub>	254 297 2.0 2.4	mW mW/°C
Thermal Resistance, Junction to Ambient	(Note 3) (Note 4)	$R_{\theta JA}$	493 421	°C/W
Thermal Resistance, Junction to Lead	(Note 3)	$R_{ ext{ heta}JL}$	193	°C/W
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C

1. FR-4 @ Minimum Pad.

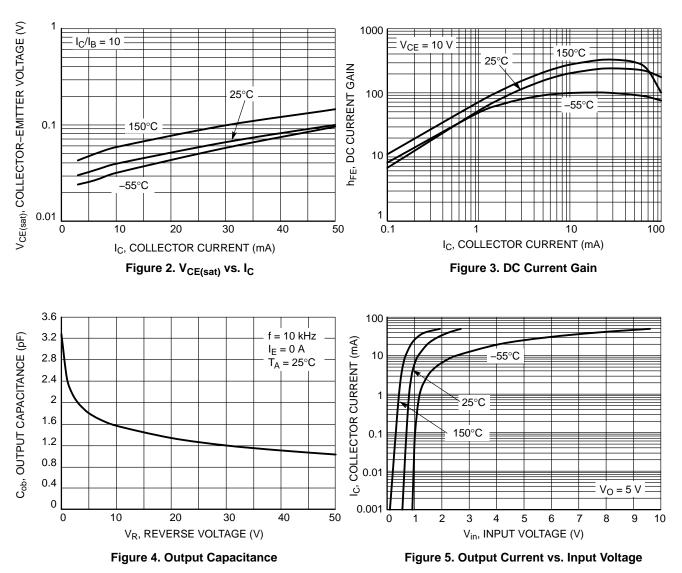
2. FR-4 @ 1.0 x 1.0 Inch Pad.

FR-4 @ 100 mm<sup>2</sup>, 1 oz. copper traces, still air.
 FR-4 @ 500 mm<sup>2</sup>, 1 oz. copper traces, still air.

#### Table 3. ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = $25^{\circ}$ C, unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	·				
Collector–Base Cutoff Current $(V_{CB} = 50 \text{ V}, I_E = 0)$	I <sub>CBO</sub>	-	-	100	nAdc
Collector–Emitter Cutoff Current ( $V_{CE} = 50 V, I_B = 0$ )	I <sub>CEO</sub>	_	_	500	nAdc
Emitter–Base Cutoff Current ( $V_{EB} = 6.0 \text{ V}, I_C = 0$ )	I <sub>EBO</sub>	_	-	0.2	mAdc
Collector–Base Breakdown Voltage $(I_C = 10 \ \mu A, I_E = 0)$	V <sub>(BR)CBO</sub>	50	-	_	Vdc
Collector–Emitter Breakdown Voltage (Note 5) $(I_C = 2.0 \text{ mA}, I_B = 0)$	V <sub>(BR)</sub> CEO	50	-	-	Vdc
ON CHARACTERISTICS			-	-	-
DC Current Gain (Note 5) ( $I_C = 5.0 \text{ mA}, V_{CE} = 10 \text{ V}$ )	h <sub>FE</sub>	80	140	_	
Collector – Emitter Saturation Voltage (Note 5) $(I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA})$	V <sub>CE(sat)</sub>	_	-	0.25	Vdc
Input Voltage (off) (V <sub>CE</sub> = 5.0 V, I <sub>C</sub> = 100 $\mu$ A)	V <sub>i(off)</sub>	_	0.7	0.5	Vdc
Input Voltage (on) ( $V_{CE} = 0.3 \text{ V}, I_C = 1.0 \text{ mA}$ )	V <sub>i(on)</sub>	1.4	0.8	-	Vdc
Output Voltage (on) (V <sub>CC</sub> = 5.0 V, V <sub>B</sub> = 2.5 V, R <sub>L</sub> = 1.0 k $\Omega$ )	V <sub>OL</sub>	_	-	0.2	Vdc
Output Voltage (off) (V <sub>CC</sub> = 5.0 V, V <sub>B</sub> = 0.5 V, R <sub>L</sub> = 1.0 k $\Omega$ )	V <sub>OH</sub>	4.9	-	-	Vdc
Input Resistor	R1	7.0	10	13	kΩ
Resistor Ratio	R <sub>1</sub> /R <sub>2</sub>	0.17	0.21	0.25	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle  $\leq 2\%$ .



TYPICAL CHARACTERISTICS MUN2214, MMUN2214L, MUN5214, DTC114YE, DTC114YM3

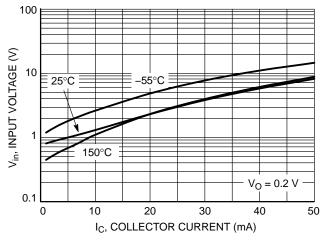
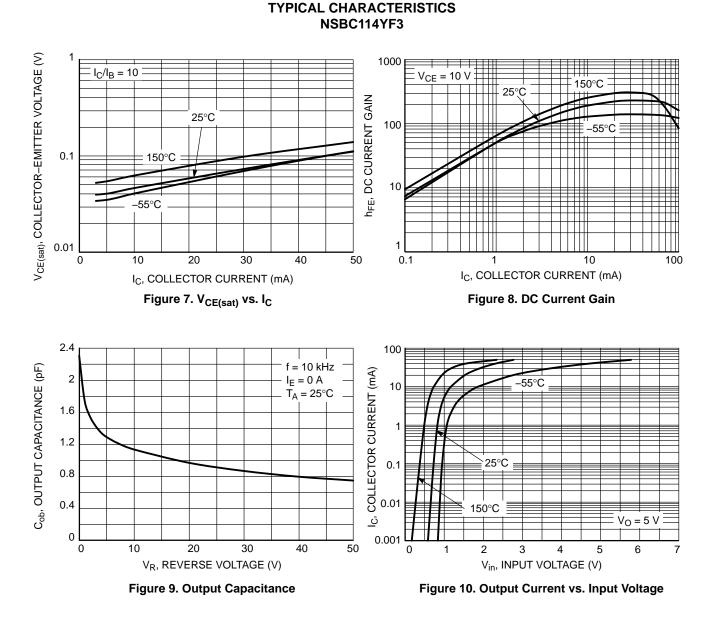


Figure 6. Input Voltage vs. Output Current



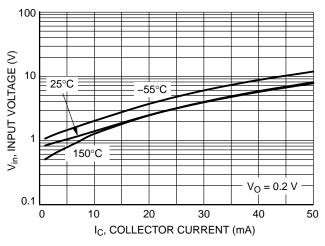


Figure 11. Input Voltage vs. Output Current

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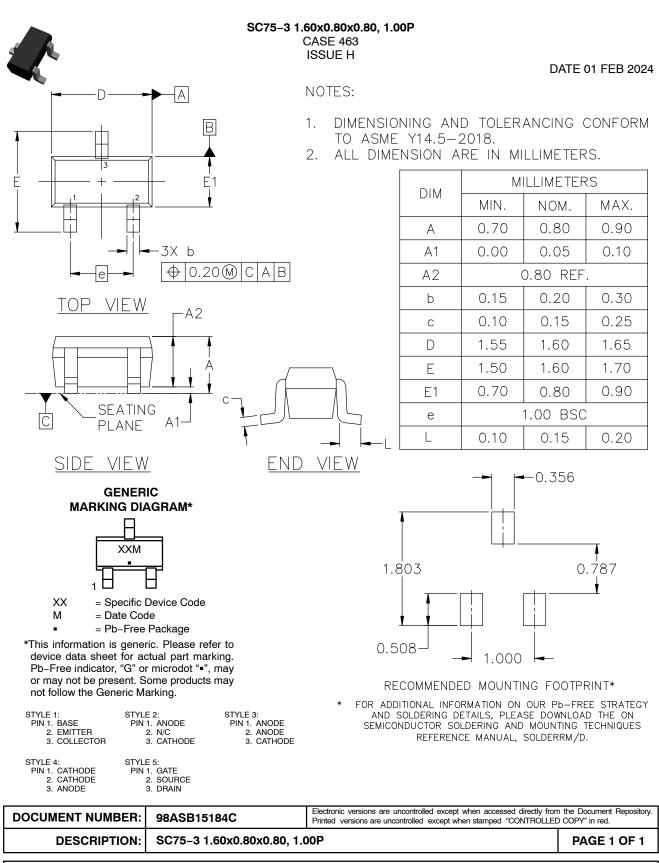
SC-70 (SOT-323) **CASE 419** ISSUE R DATE 11 OCT 2022 SCALE 4:1 NDTES: Π DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982. 1. CONTROLLING DIMENSION: INCH 2. MILLIMETERS INCHES MIN. MIN. NDM. DIM NDM. MAX MAX. А 0.80 0.90 1.00 0.032 0.035 0.040 0.004 A1 0.00 0.05 0.10 0.000 0.002 0.70 REF 0.028 BSC Α2 b b 0.30 0.35 0.40 0.012 0.014 0.016 e 0.007 0.010 0.10 0.18 0.25 0.004 С TOP VIEW 0.080 0.087 D 1.80 2.00 2.20 0.071 E 1.15 1.24 1.35 0.045 0.049 0.053 e 1.20 1.30 1.40 0.047 0.051 0.055 0.65 BSC e1 0.026 BSC 0.05 (0.002) A2 L 0.20 0.38 0.56 0.008 0.015 0.022 Δ1 2.00 SIDE VIEW HE 2.10 2.40 0.079 0.083 0.095 END VIEW -0.65 [0.025] 0.65 [0.025]-1.90 [0.075] GENERIC MARKING DIAGRAM 0.90 [0.035] XX M= -0.70 [0.028] For additional information on our Pb-Free strategy and soldering details, please download the DN Seniconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D. SOLDERING FOOTPRINT XX = Specific Device Code М = Date Code = Pb-Free Package \*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking. STYLE 1: CANCELLED STYLE 2: STYLE 3: STYLE 4: STYLE 5: PIN 1. ANODE 2. N.C. PIN 1. BASE PIN 1. CATHODE 2. CATHODE PIN 1. ANODE 2. EMITTER 2. ANODE 3. CATHODE 3. COLLECTOR 3. ANODE 3. CATHODE STYLE 6: STYLE 9: STYLE 10: STYLE 11: STYLE 7: STYLE 8: PIN 1. EMITTER PIN 1. BASE PIN 1. GATE PIN 1. ANODE PIN 1. CATHODE PIN 1. CATHODE 2. EMITTER 2. CATHODE 2. SOURCE 2. CATHODE 2. BASE 2. ANODE 3. COLLECTOR 3. COLLECTOR 3. DRAIN 3. CATHODE-ANODE 3. ANODE-CATHODE 3. CATHODE Electronic versions are uncontrolled except when accessed directly from the Document Repository. **DOCUMENT NUMBER:** 98ASB42819B Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SC-70 (SOT-323) PAGE 1 OF 1

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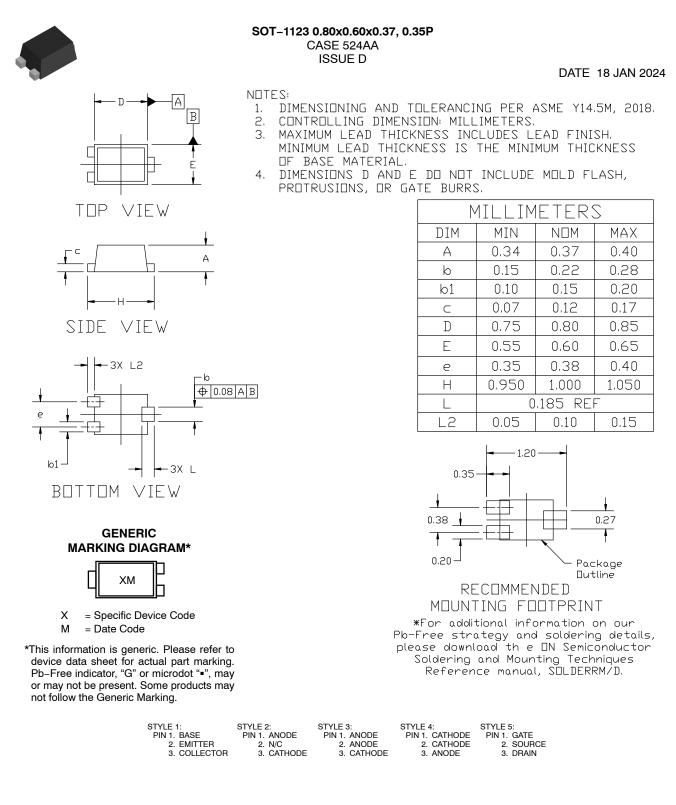
## MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



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DESCRIPTION:	SOT-1123 0.80x0.60x0.37, 0.35P		PAGE 1 OF 1

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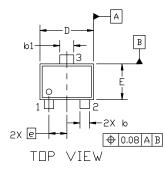


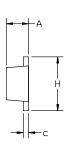
#### SOT-723 1.20x0.80x0.50, 0.40P CASE 631AA ISSUE E

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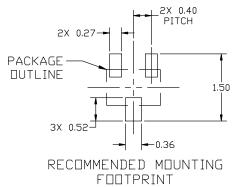
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSION: MILLIMETERS. 1.
- 2.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM З. LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS OR GATE BURRS.



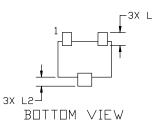


SIDE VIEW

		MILLIMETERS				
	DIM	MIN.	NDM.	MAX,		
1	А	0.45	0.50	0.55		
	b	0.15	0.21	0.27		
	b1	0.25	0.31	0.37		
	С	0.07	0.12	0.17		
	D	1.15	1.20	1,25		
	E	0.75	0.80	0.85		
	e	0.40 BSC				
	Н	1.15	1.20	1.25		
	L		0.29 REF	-		
	L2	0.15	0.20	0.25		



\*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.



GENERIC **MARKING DIAGRAM\*** 



XX = Specific Device Code Μ = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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PIN 1. BASE 2. EMITTER 3. COLLECTOR	PIN 1. ANO 2. N/C 3. CATH	2. ANODE	2.	CATHODE CATHODE ANODE	PIN 1. GATE 2. SOURCE 3. DRAIN		
STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4		STYLE 5:		

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